

Serial No.:

10/020,153

Filed:

December 18, 2001

For:

SEMICONDUCTOR DEVICE

Docket No.:

KAN 137

February 14, 2003

AMENDMENT

AFTER FINAL

BOX: AF

Assistant Commissioner of **Patents and Trademarks** Washington, D.C. 20231

Sir:

In response to the Examiner's Action mailed on November 18, 2002, please amend the above-identified application as follows:

IN THE CLAIMS:

Please amend the following claim:

1. (Twice Amended) A semiconductor device, comprising:

a semiconductor substrate having a circuit forming surface, and having a plurality of electrode pads provided on the circuit foliming surface, said electrode pads being disposed to surround an area of the circuit forming surface;

a semiconductor element mounted within the area of the circuit forming surface;

a plurality of adhesive lines adapted for use as reference lines, said adhesive lines being disposed under the semiconductor\element and on the circuit forming surface, and being respectively provided at positions corresponding to at least three